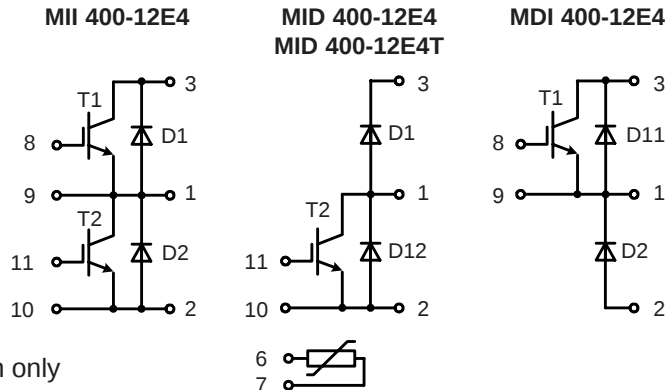


IGBT Module

phaseleg and chopper topologies
with optional temperature sensor

$$\begin{aligned} I_{C25} &= 420 \text{ A} \\ V_{CES} &= 1200 \text{ V} \\ V_{CE(sat) \text{ typ.}} &= 2.2 \text{ V} \end{aligned}$$



IGBTs T1-T2

Symbol	Conditions	Maximum Ratings	
V_{CES}	$T_{VJ} = 25^{\circ}\text{C to } 150^{\circ}\text{C}$	1200	V
V_{GES}		± 20	V
I_{C25}	$T_C = 25^{\circ}\text{C}$	420	A
I_{C80}	$T_C = 80^{\circ}\text{C}$	300	A
I_{CM}	$V_{GE} = \pm 15 \text{ V}; R_G = 4.7 \Omega; T_{VJ} = 125^{\circ}\text{C}$	450	A
V_{CEK}	RBSOA , Clamped inductive load; $L = 100 \mu\text{H}$	V_{CES}	
t_{SC} (SCSOA)	$V_{CE} = 900 \text{ V}; V_{GE} = \pm 15 \text{ V}; R_G = 4.7 \Omega; T_{VJ} = 125^{\circ}\text{C}$ non repetitive	10	μs
P_{tot}	$T_C = 25^{\circ}\text{C}$	1700	W

Symbol	Conditions	Characteristic Values ($T_{VJ} = 25^{\circ}\text{C}$, unless otherwise specified)		
		min.	typ.	max.
$V_{CE(sat)}$	$I_C = 300 \text{ A}; V_{GE} = 15 \text{ V}; T_{VJ} = 25^{\circ}\text{C}$ $T_{VJ} = 125^{\circ}\text{C}$		2.2 2.6	2.8 V
$V_{GE(th)}$	$I_C = 10 \text{ mA}; V_{GE} = V_{CE}$	4.5		6.5 V
I_{CES}	$V_{CE} = V_{CES}; V_{GE} = 0 \text{ V}; T_{VJ} = 25^{\circ}\text{C}$ $T_{VJ} = 125^{\circ}\text{C}$		0.8 3.5	3.3 mA
I_{GES}	$V_{CE} = 0 \text{ V}; V_{GE} = \pm 20 \text{ V}$			600 nA
$t_{d(on)}$ t_r $t_{d(off)}$ t_f E_{on} E_{off}	Inductive load, $T_{VJ} = 125^{\circ}\text{C}$ $V_{CE} = 600 \text{ V}; I_C = 300 \text{ A}$ $V_{GE} = \pm 15 \text{ V}; R_G = 4.7 \Omega$		150 60 680 50 36 30	ns ns ns ns mJ mJ
C_{ies}			17	nF
Q_{Gon}			2.25	μC
R_{thJC} R_{thJH}	(per IGBT) with heatsink compound		0.15	0.08 K/W K/W

Features

- NPT³ IGBT
 - low saturation voltage
 - positive temperature coefficient
 - fast switching
 - short tail current for optimized performance in resonant circuits
- HiPerFREDTM diodes
 - fast and soft reverse recovery
 - low operating forward voltage
 - low leakage current
- NTC sensor for measurement of case temperature
- Package
 - low inductive current path
 - screw connection to high current main terminals
 - use of non interchangeable connectors for auxiliary terminals possible
 - kelvin emitter terminal for easy drive
 - isolated ceramic base plate

Applications

- drives
 - AC
 - DC
- power supplies
 - rectifiers with power factor correction
 - and recuperation capability
- UPS

Free wheeling diodes D1-D2

Symbol	Conditions	Maximum Ratings	
I_{F25}	$T_C = 25^\circ\text{C}$	450	A
I_{F80}	$T_C = 80^\circ\text{C}$	290	A

Symbol	Conditions	Characteristic Values		
		min.	typ.	max.
V_F	$I_F = 300\text{ A}; V_{GE} = 0\text{ V}; T_{VJ} = 25^\circ\text{C}$		2.3	2.7 V
	$T_{VJ} = 125^\circ\text{C}$		1.7	V
I_{RM} t_{rr}	$I_F = 225\text{ A}; di_F/dt = -2000\text{ A}/\mu\text{s}; T_{VJ} = 125^\circ\text{C}$ $V_R = 600\text{ V}; V_{GE} = 0\text{ V}$		200	A
			220	ns
R_{thJC} R_{thJH}	(per diode) with heatsink compound	0.3		0.15 K/W K/W

Chopper anti parallel diodes D11-D12

Symbol	Conditions	Maximum Ratings	
I_{F25}	$T_C = 25^\circ\text{C}$	150	A
I_{F80}	$T_C = 80^\circ\text{C}$	95	A

Symbol	Conditions	Characteristic Values		
		min.	typ.	max.
V_F	$I_F = 100\text{ A}; V_{GE} = 0\text{ V}; T_{VJ} = 25^\circ\text{C}$		2.3	2.7 V
	$T_{VJ} = 125^\circ\text{C}$		1.7	V
I_{RM} t_{rr}	$I_F = 75\text{ A}; di_F/dt = -750\text{ A}/\mu\text{s}; T_{VJ} = 125^\circ\text{C}$ $V_R = 600\text{ V}; V_{GE} = 0\text{ V}$		80	A
			220	ns
R_{thJC} R_{thJH}	(per diode) with heatsink compound	0.9		0.45 K/W K/W

Temperature Sensor NTC (...T version only)

Symbol	Conditions	Characteristic Values		
		min.	typ.	max.
R_{25} $B_{25/100}$	$T = 25^\circ\text{C}$ $\left\{ R(T) = R_{25} \cdot e^{B_{25/100} \left(\frac{1}{T} - \frac{1}{298\text{K}} \right)} \right\}$		2057 3560	Ω K

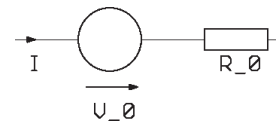
Module

Symbol	Conditions	Maximum Ratings	
T_{VJ} T_{stg}		-40...+150 -40...+125	$^\circ\text{C}$ $^\circ\text{C}$
V_{ISOL}	$I_{ISOL} \leq 1\text{ mA}; 50/60\text{ Hz}$	4000	V~
M_d	Mounting torque	(module, M6) (terminals, M6)	2.25 - 2.75 4.5 - 5.5 Nm Nm

Symbol	Conditions	Characteristic Values		
		min.	typ.	max.
d_s d_A	Creepage distance on surface Strike distance in air	2 2		mm mm
Weight		250		g

Equivalent Circuits for Simulation

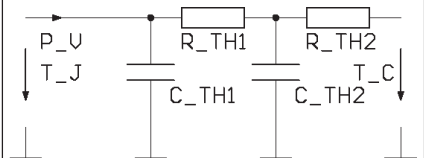
Conduction



IGBT (typ. at $V_{GE} = 15\text{ V}; T_J = 125^\circ\text{C}$)
 $V_0 = 1.0\text{ V}; R_0 = 5.3\text{ m}\Omega$

Free Wheeling Diode D1-D2 (typ. at $T_J = 125^\circ\text{C}$)
 $V_0 = 1.3\text{ V}; R_0 = 1.3\text{ m}\Omega$

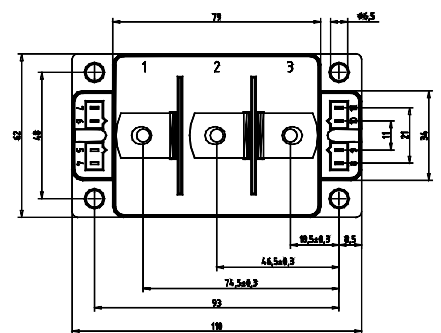
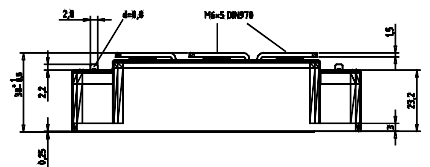
Thermal Response



IGBT (typ.)
 $C_{th1} = 0.52\text{ J/K}; R_{th1} = 0.078\text{ K/W}$
 $C_{th2} = 1.29\text{ J/K}; R_{th2} = 0.002\text{ K/W}$

Free Wheeling Diode D1-D2 (typ.)
 $C_{th1} = 0.43\text{ J/K}; R_{th1} = 0.147\text{ K/W}$
 $C_{th2} = 0.79\text{ J/K}; R_{th2} = 0.003\text{ K/W}$

Dimensions in mm (1 mm = 0.0394")



Optional accessories for modules

keyed twin plugs
(UL758, style 1385, CSA class 5851, guide 460-1-1)

- Type ZY180L with wire length 350mm
– for pins 4 (yellow wire) and 5 (red wire)
– for pins 11 (yellow wire) and 10 (red wire)
- Type ZY180R with wire length 350mm
– for pins 7 (yellow wire) and 6 (red wire)
– for pins 8 (yellow wire) and 9 (red wire)

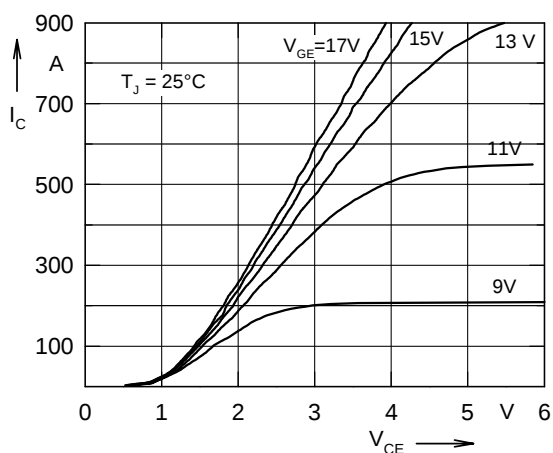


Fig. 1 Typ. output characteristics

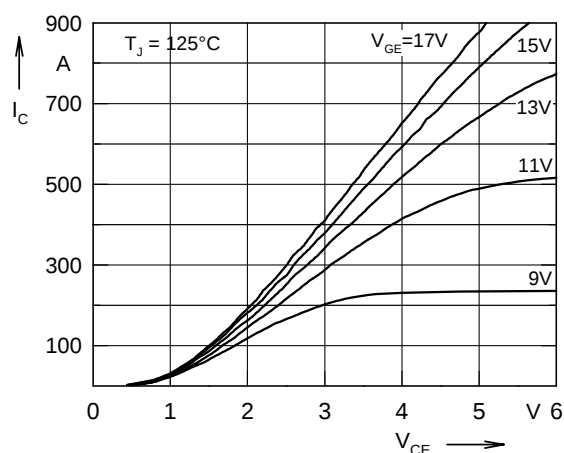


Fig. 2 Typ. output characteristics

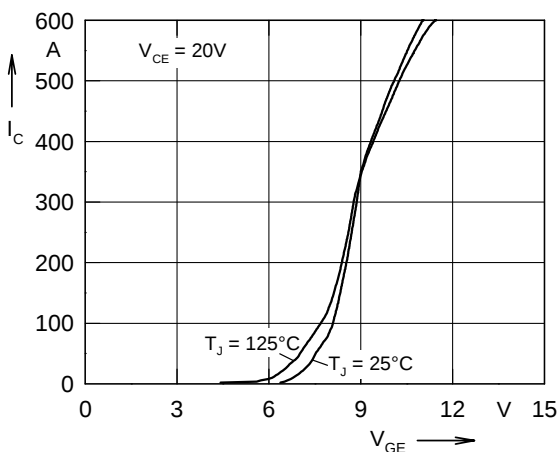


Fig. 3 Typ. transfer characteristics

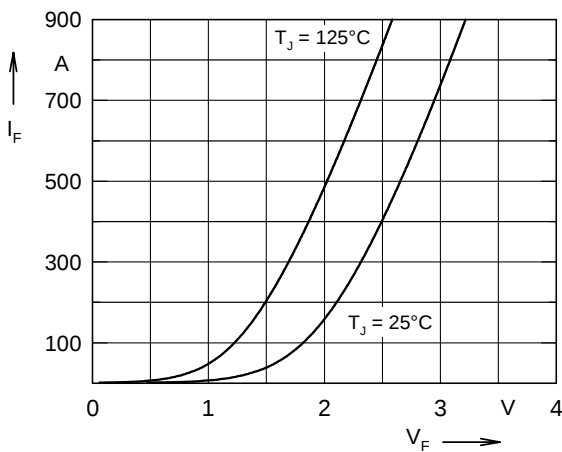


Fig. 4 Typ. forward characteristics of free wheeling diode D1-D2

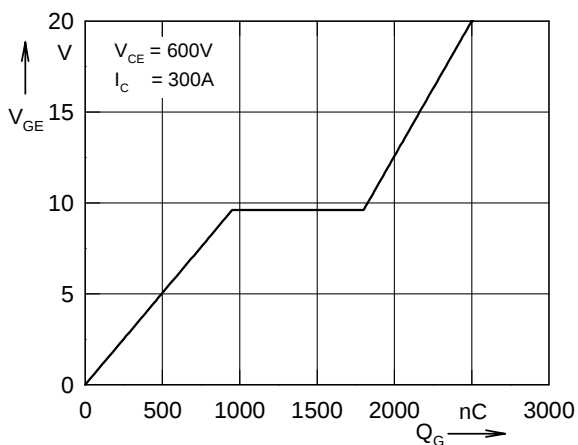


Fig. 5 Typ. turn on gate charge

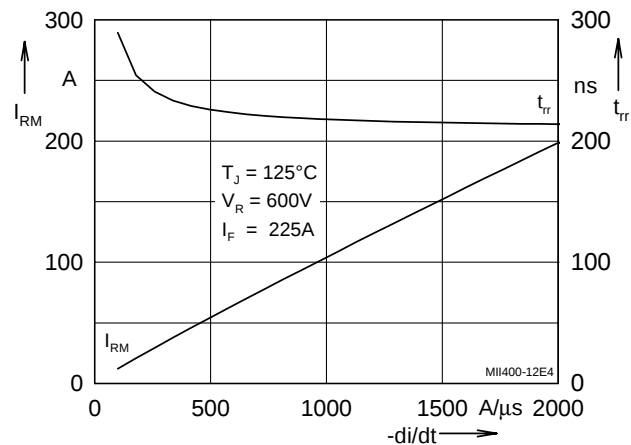


Fig. 6 Typ. turn off characteristics of free wheeling diode D1-D2

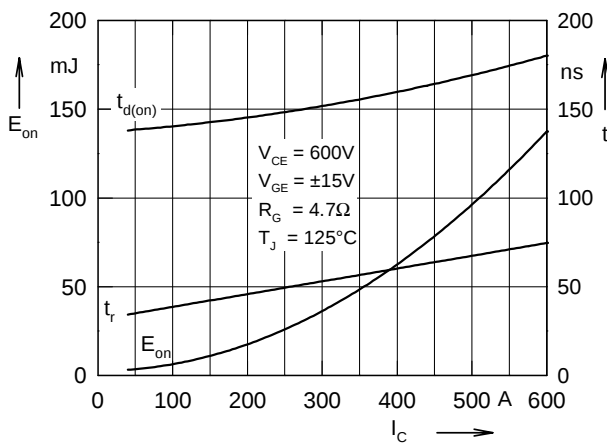


Fig. 7 Typ. turn on energy and switching times versus collector current

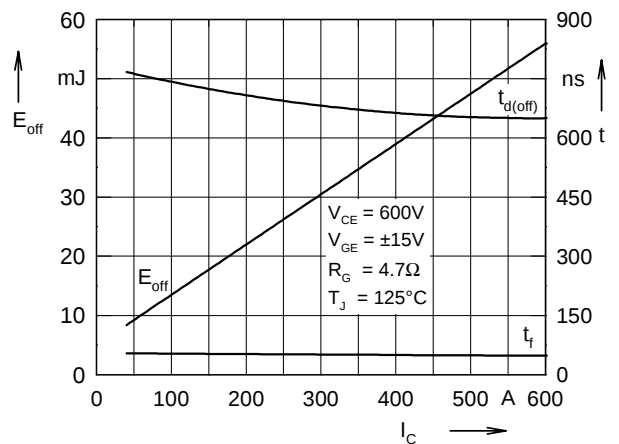


Fig. 8 Typ. turn off energy and switching times versus collector current

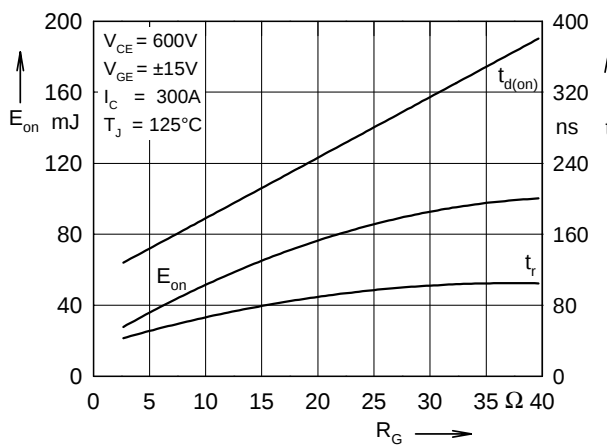


Fig. 9 Typ. turn on energy and switching times versus gate resistor

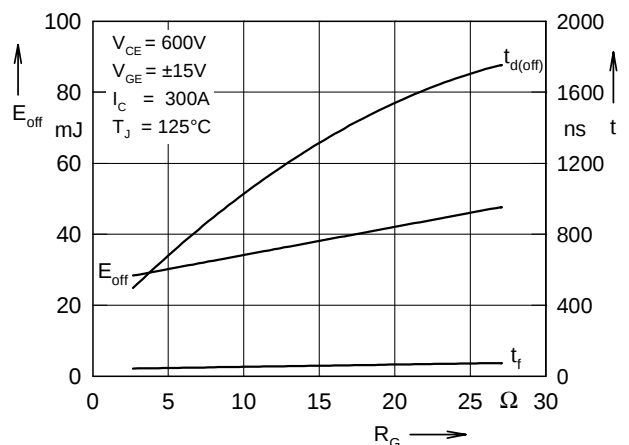


Fig. 10 Typ. turn off energy and switching times versus gate resistor

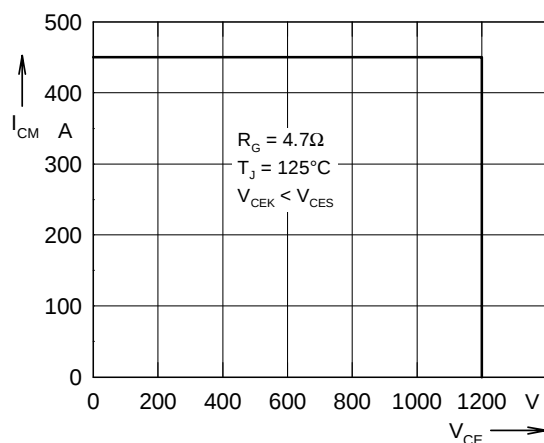


Fig. 11 Reverse biased safe operating area RBSOA

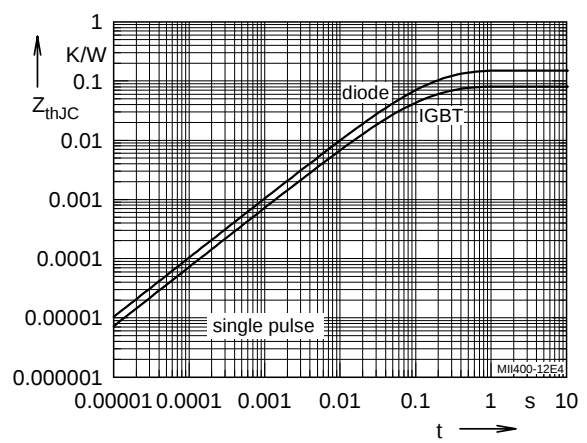


Fig. 12 Typ. transient thermal impedance